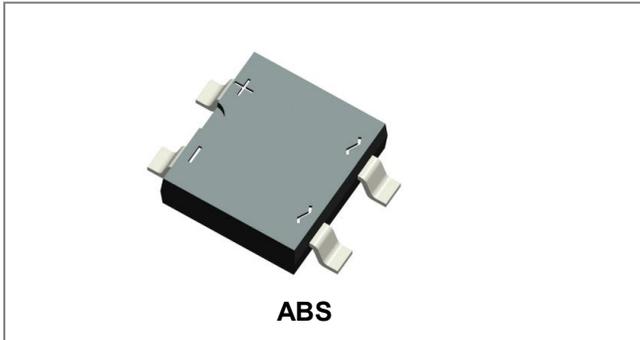


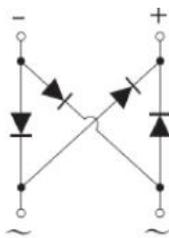
**ABS2U THRU ABS10U**  
**SINGLE PHASE 1.0AMP SURFACE MOUNT GLASS PASSIVATED BRIDGE RECTIFIER**



**Features**

- Glass passivated die construction
- Low forward voltage drop
- High current capability
- High surge current capability
- Designed for surface mount application
- Plastic material-UL flammability 94V-0
- This is a Pb – Free Device
- “-HF” suffix is for Halogen Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

**Circuit Diagram**



**Mechanical Data**

- Case: SOPA-4, Molded plastic ABS
- Terminals: Plated leads solderable per MIL-STD-202, Method 208
- Polarity: as marked on case
- Mounting Position: Any

**Maximum Ratings and Electrical Characteristics @T<sub>A</sub>=25°C unless otherwise specified**

Single Phase half wave 60Hz, resistive or inductive load. For capacitive load current derate by 20%.

Type Number	Symbol	ABS2U	ABS4U	ABS6U	ABS8U	ABS10U	Units	
ABS2U-HF THRU ABS10U-HF Marking Code		ABS2UH	ABS4UH	ABS6UH	ABS8UH	ABS10UH	Units	
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>							
Working Peak Reverse Voltage	V <sub>RWM</sub>	200	400	600	800	1000	V	
DC Blocking Voltage	V <sub>DC</sub>							
RMS Reverse Voltage	V <sub>RMS</sub>	140	280	420	560	700	V	
Maximum Average Rectified Output Current @T <sub>A</sub> =30°C	I <sub>(AV)</sub>	1						V
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I <sub>FSM</sub>	35						A

**Electrical Characteristics@T<sub>A</sub>=25°C unless otherwise specified**

Type Number	Symbol	ABS2U	ABS4U	ABS6U	ABS8U	ABS10U	Units
ABS2U-HF THRU ABS10U-HF Marking Code		ABS2UH	ABS4UH	ABS6UH	ABS8UH	ABS10UH	Units
Maximum Forward Voltage (per element) @I <sub>F</sub> =1A	V <sub>F</sub>	1.1					V
Maximum Peak Reverse Current @T <sub>A</sub> = 25°C At Rated DC Blocking Voltage @T <sub>A</sub> = 125°C	I <sub>R</sub>	5.0 500					μA

\* Pulse width < 300 μs, duty cycle < 2%

**Thermal-Mechanical Specifications@T<sub>A</sub>=25°C unless otherwise specified**

Type Number	Symbol	ABS2U	ABS4U	ABS6U	ABS8U	ABS10U	Units
ABS2U-HF THRU ABS10U-HF Marking Code		ABS2UH	ABS4UH	ABS6UH	ABS8UH	ABS10UH	Units
Typical Thermal Resistance(Note 1)	R <sub>θJA</sub> R <sub>θJL</sub>	62.5 25					°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150					°C

Note: 1. Thermal resistance from junction to ambient and junction to lead mounted on P.C.B. with 0.2X0.2"(5X5mm) copper pads.

**Ratings and Characteristics Curves**

FIG.1 MAXIMUM FORWARD CURRENT DERATING CURVE

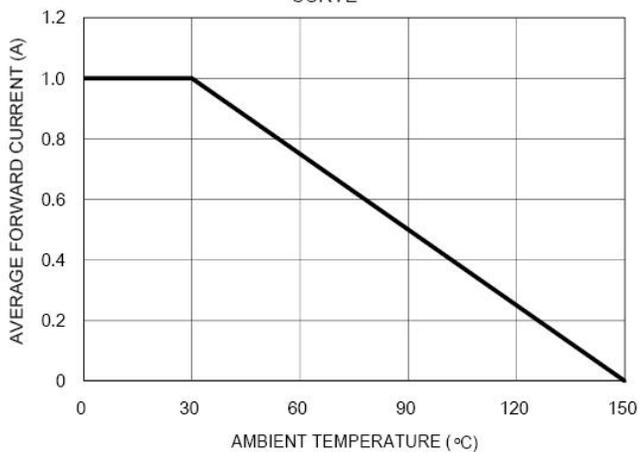
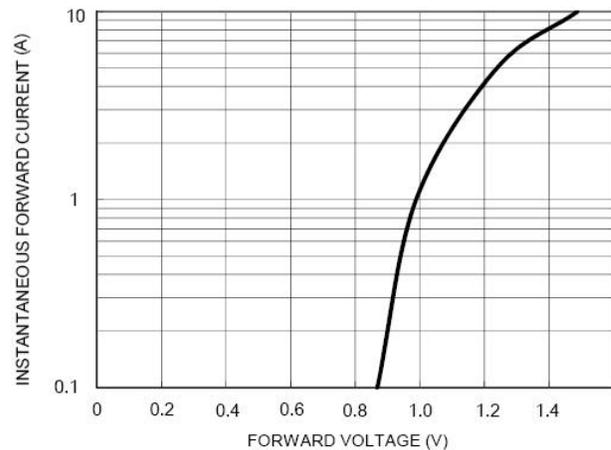
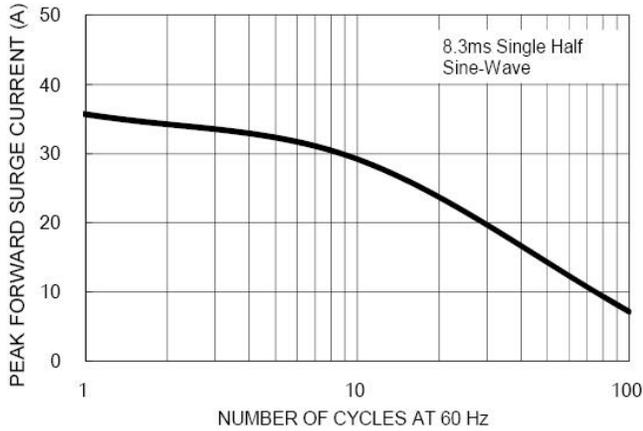


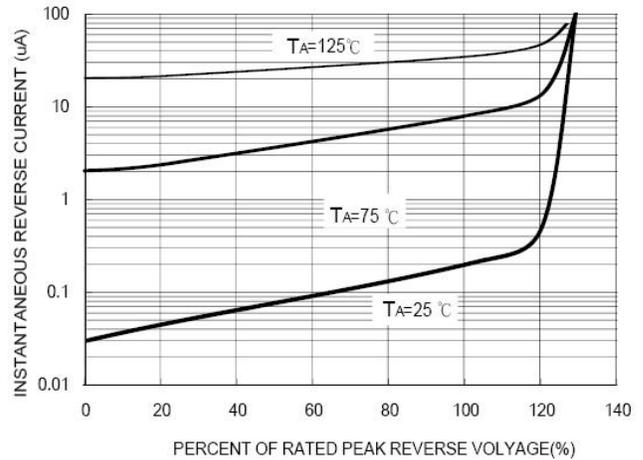
FIG. 2 TYPICAL FORWARD CHARACTERISTIC



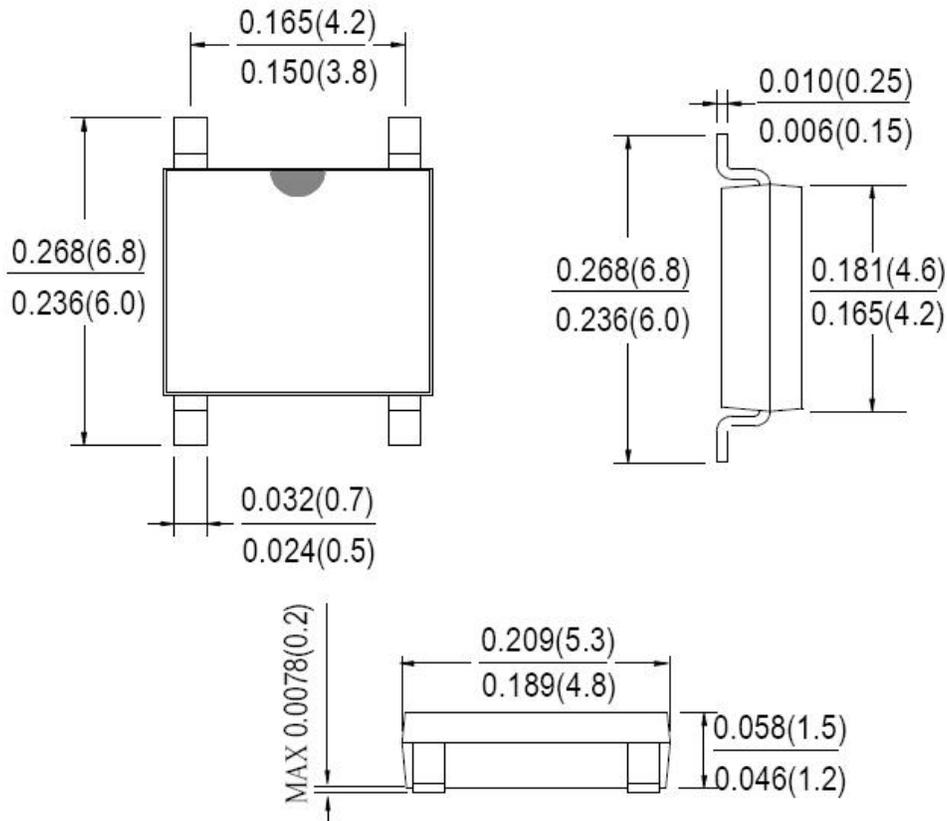
**FIG. 3 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT**



**FIG. 4 TYPICAL REVERSE CHARACTERISTICS**



**Mechanical Dimensions ABS(Inches/Millimeters)**

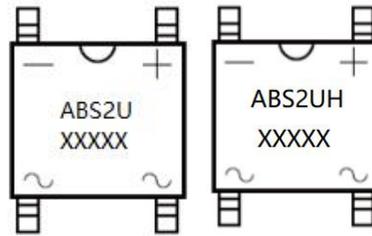


**Ordering Information**

Device	Package	Plating	Shipping
ABS2U THRU ABS10U	ABS	Pure Sn	5000pcs / reel
ABS2UTR THRU ABS10UTR	ABS	Pure Sn	5000pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

**Marking Diagram**



ABS2U

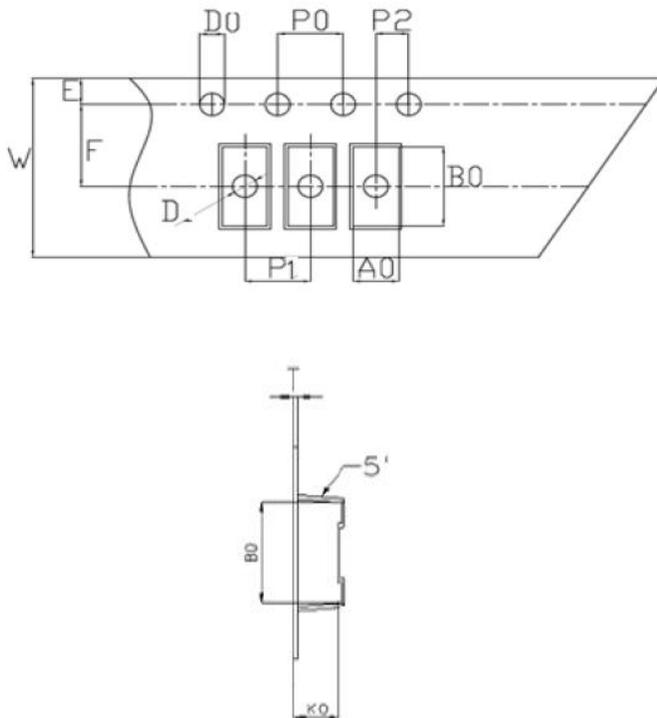
ABS2U-HF

Where XXXXX is YYWWL

ABS2U = Type Number  
 ABS2UH = Marking Code  
 YY = Year  
 WW = Week  
 L = Lot Number

**Cautions:** Molding resin  
 Epoxy resin UL:94V-0

**Carrier Tape Specification ABS**



SYMBOL	Millimeters	
	Min.	Max.
A0	5.21	5.41
B0	7.10	7.30
D0	1.50	1.60
D1	1.40	1.60
P0	3.90	4.10
P1	7.90	8.10
P2	1.95	2.05
E	1.65	1.85
K0	1.55	1.75
F	5.45	5.55
W	11.90	12.10
T	0.24	0.30
10P0	39.80	40.20

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